

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Priority Application Serial No. .... 09/392,073  
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Inventor ..... Rickie C. Lake et al  
Assignee ..... Micron Technology, Inc.  
Priority Group Art Unit ..... 1751  
Priority Examiner ..... D. Hamlin  
Attorney's Docket No. .... MI40-327  
Title: An Epoxy, Epoxy System, and Method of Forming a Conductive  
Adhesive Connection

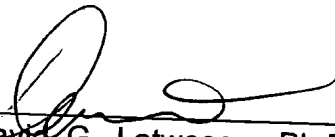
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